



Product data sheet

1. General description

Ultrafast power diode in TO252 (DPAK) plastic package.

2. Features and benefits

- Low forward voltage drop
- Low leakage current
- Soft reverse recovery characteristics
- High thermal cycling performance

3. Applications

- Home appliance power supply
- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)

4. Quick reference data

Cumple of	Devenueter	Canditiana					Link
Symbol	Parameter	Conditions	Values			Unit	
Absolute	maximum rating						
V _{RRM}	repetitive peak reverse voltage			6	00		V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 157 °C; Fig. 1; Fig. 2; Fig. 3	10			A	
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 µs; T _{mb} ≤ 157 °C; square-wave pulse	20			A	
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4				А	
		$t_{\rm p}$ = 8.3 ms; $T_{j(\text{init})}$ = 25 °C; sine-wave pulse			А		
Symbol	Parameter	Conditions	Min Typ Max		Unit		
Static ch	aracteristics						
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.07	1.3	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 5</u>		-	0.92	1.1	V
Dynamic	characteristics	·					
t _{rr}	reverse recovery time $I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}I_F/\text{d}t = 100 \text{ A}/\mu\text{s};$ $T_i = 25 \text{ °C}; \text{ Fig. 6}$		-	40	75	ns	
	1	•			1	1	· · · · · · · · · · · · · · · · · · ·

5. Pinning information

Table 2. P	inning inforr	mation				
Pin	Symbol	Description	Simplified outline	Graphic symbol		
1	А	anode	2			
2	К	cathode [1]		K — — A 001aaa020		
3	А	anode				
mb	К	mounting base; cathode				

[1] It is not possible to connect to pin 2 of the TO252 package.

6. Ordering information

Table 3. Ordering in	formation					
Type number	Package	Orderable part number	Packing	Small packing	Package	Package
	Name		method	quantity	version	issue date
BYV10D-600P	TO252	BYV10D-600PJ	Reel	2500	TO252N	14-Nov-2016

7. Marking

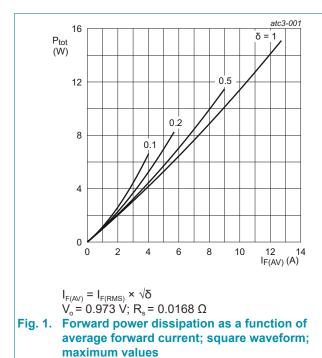
Table 4. Marking codes		
Type number	Marking codes	
BYV10D-600P	BYV10D	
	600P	

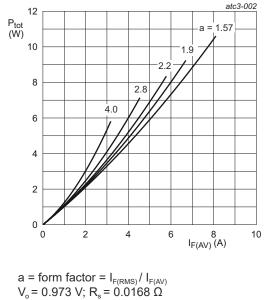
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

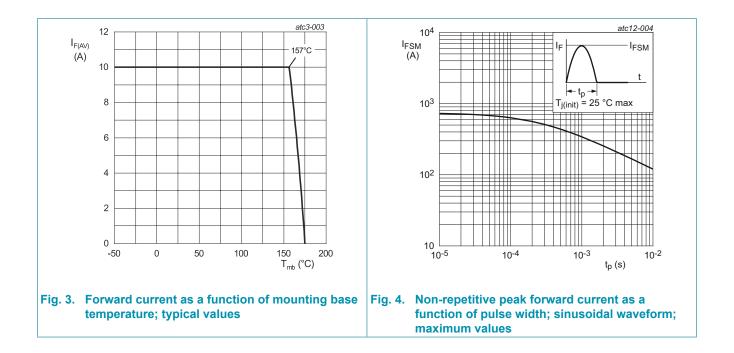
Symbol	Parameter	Conditions	Values	Unit
V _{RRM}	repetitive peak reverse voltage		600	V
V _{RWM}	crest working reverse voltage		600	V
V _R	reverse voltage	DC	600	V
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 157 °C; Fig. 1; Fig. 2; Fig. 3	10	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 µs; T _{mb} ≤ 157 °C; square-wave pulse	20	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	120	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	132	А
T _{stg}	storage temperature		-55 to 175	°C
T _j	junction temperature		175	°C





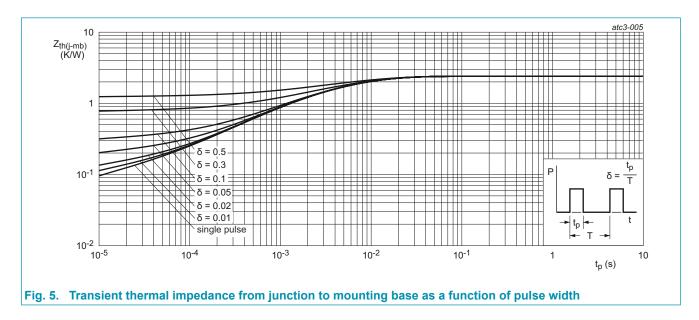
 $V_o = 0.973 V$; $R_s = 0.0168 \Omega$ Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

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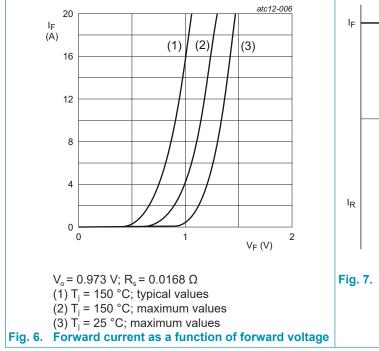
9. Thermal characteristics

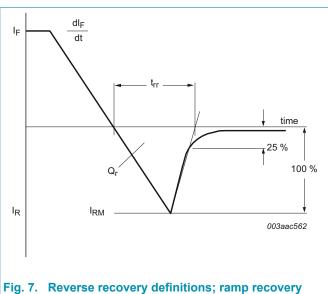
able 6. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	-	2.4	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air	-	60	-	K/W



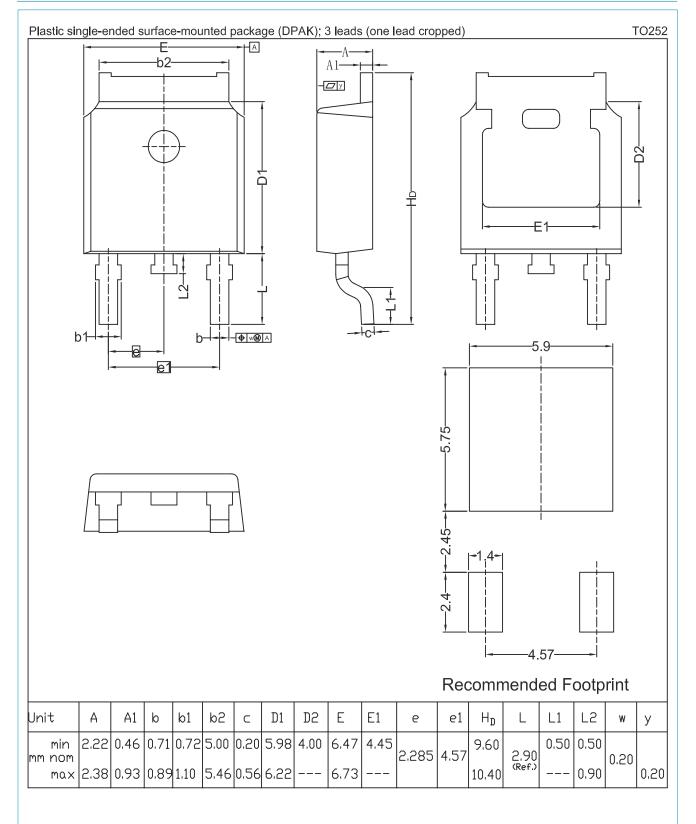
10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; <u>Fig. 6</u>	-	1.07	1.3	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 6</u>	-	0.92	1.1	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C	-	-	10	μA
		V _R = 600 V; T _j = 100 °C	-	-	0.4	mA
		V _R = 300 V; T _j = 125 °C	-	20.5	100	μA
Dynamic	characteristics					
Q _r	recovered charge	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	55	-	nC
		$I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}I_F/\text{d}t = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	50	-	nC
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	40	75	ns
		$I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}I_F/\text{d}t = 50 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	56	100	ns
I _{RM}	peak reverse recovery current	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$	-	2.8	-	A
		$I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}I_F/\text{d}t = 50 \text{ A}/\mu\text{s};$ $T_i = 25 \text{ °C}; \frac{\text{Fig. 7}}{2}$	-	1.9	-	А





11. Package outline



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Ultrafast power diode

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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